IN THE CLAIMS:

We claim:

1. A digital thermometer comprising:

a housing having first and second portions, the first portion defining a cavity;

a waterproof seal disposed between the first and second portions of the housing;

temperature conversion logic disposed within the cavity of said housing, said temperature conversion logic being encapsulated by a material having low thermal conductivity;

an insulating member disposed in the cavity of said housing;

a probe connected to said housing; and

a temperature sensing element disposed in said probe.

- 2. The digital thermometer of claim 1 wherein the waterproof seal includes an ultrasonic weld.
- 3. The digital thermometer of claim 1 wherein the water proof seal includes a temperature resistant glue.
- 4. The digital thermometer of claim 1 wherein the waterproof seal includes a gasket and a screw interconnecting the first and second portions of the housing.
- 5. The digital thermometer of claim 1 wherein the temperature conversion logic is encapsulated by epoxy.
- 6. The digital thermometer of claim 1wherien the insulating member comprises foam.
- 7. The digital thermometer of claim 1 wherein the insulating member comprises polystyrene.

8. A method of making a digital thermometer comprising:

encapsulating a microprocessor in a material having low thermal conductivity;

inserting the microprocessor in a cavity of a first portion of a thermometer housing;

applying a sufficient amount of insulation to the cavity to fill the cavity;

sealing a second portion of the thermometer housing to the first portion of the thermometer housing; and

connecting a probe to the thermometer housing.